## **General Description**

The MAX24101 restores high-frequency signal level at the decision-feedback equalizer (DFE) receiver for highloss backplane and cable channels. This permits the DFE receiver to meet BER goals. At 15Gbps, the MAX24101 can operate in channels with FR4 and cable HF loss more of than 30dB at 7.5GHz. The linear transfer function is transparent to Adaptive DFE equalizers, permitting DFE adaptation to track temperature and changing channel conditions.

Together with the DFE, integrated into Serializer/ Deserializer (SERDES), the device adds increased margin rather than full signal regeneration. Unlike conventional equalizers with limiting output stages, the device preserves the linear channel characteristics, allowing the DFE to linearly operate over the entire channel. This permits extending total channel reach and/or improving signal-to-noise ratio (SNR). The device typically compensates for up to 19dB of the total loss in a long channel, effectively reducing the channel length seen by the DFE receiver.

The device has 8 channels and is packaged in a spacesaving, 4mm x 13mm, FCLGA package.

## **Applications**

- 1Gbps to 15Gbps High-Speed Backplanes and Cables
- 12.5Gbps Quad XAUI Interconnect

**Typical Application Circuit**

- 14Gbps 16G Fiber Channel
- 12Gbps SAS III

## **Benefits and Features**

- 1Gbps to 15Gbps Linear EQ
- Increases High-Frequency Signal Level To Help Rx DFE Achieve BER Goals
- ● Lower Power, Lower Cost, And Smaller Board Footprint Than CDR Solutions
- ● Transparent-to-Link Training, OOB And Idle
- Plug and Play—Set Control Pins (All Channels Set the Same) or Independent Control of Each Channel through I2C Bus
- I<sup>2</sup>C Daisy Chain For Addressing Up to 63 ICs
- Selectable EQ Peaking Spanning +6dB to +19dB at 7.5GHz
- Selectable Flat Gain Spanning -2.9dB to +1.7dB
- Selectable Output Linear Swing Spanning 700mV<sub>P-P</sub> to  $1000$ m $V_{P-P}$
- $\bullet$  Low Input-Referred Noise < 1mV<sub>RMS</sub>
- Data-Rate and Coding Agnostic
- ● Input Return Loss Better Than 16dB Typical Up to 7.5GHz
- Power-Down Mode Saves Power When Not In Use
- 4mm x 13mm FCLGA Package
- Single 2.5V Supply
- 131mW Per Channel Power Dissipation with a 700mV<sub>P-P</sub> Output



*[Ordering Information](#page-25-0) appears at end of data sheet.*

*For related parts and recommended products to use with this part, refer to www.maximintegrated.com/MAX24101.related.*



## **Absolute Maximum Ratings**





Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these *or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

## **Package Thermal Characteristics (Note 1)**

FCLGA

Junction-to-Case Thermal Resistance ( $\theta$ JC)...............10°C/W Junction-to-Ambient Thermal Resistance (qJA) (EIA/JESD51-2 standard)...................................29°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maximintegrated.com/thermal-tutorial**.

## **Operating Conditions**



## **Electrical Characteristics**

(Typical values are at  $V_{CCR} = V_{CCT} = V_{CCP} = 2.5V$ ,  $T_A = +25^{\circ}$ C. See [Figure 1](#page-5-0) for typical supply filtering.) (Note 2)



## **Electrical Characteristics (continued)**

(Typical values are at V $_{\rm CCR}$  = V $_{\rm CCT}$  = V $_{\rm CCP}=$  2.5V, T $_{\sf A}$  = +25°C. See  $_{\rm Figure~1}$  for typical supply filtering.) (Note 2)



## **Electrical Characteristics (continued)**

(Typical values are at V<sub>CCR</sub> = V<sub>CCT</sub> = V<sub>CCP</sub> = 2.5V, T<sub>A</sub> = +25°C. See [Figure 1](#page-5-0) for typical supply filtering.) (Note 2)



## **Electrical Characteristics (continued)**

(Typical values are at V<sub>CCR</sub> = V<sub>CCT</sub> = V<sub>CCP</sub> = 2.5V, T<sub>A</sub> = +25°C. See [Figure 1](#page-5-0) for typical supply filtering.) (Note 2)



**Note 2:** The MAX24101 is 100% production tested at  $T_A$  = +25°C and  $T_A$  = +85°C. Specification at  $T_A$  = -40°C is guaranteed by design or characterization, unless otherwise noted.

**Note 3:** Guaranteed by design and characterization.

Note 4: Measured with circuit board loss optimized for best DJ. Residual jitter is the difference in deterministic jitter between the reference data source and device output. DJRESIDUAL = DJOUTPUT – DJSOURCE. The deterministic jitter at the output of the transmission line must be from media induced loss. Measured at point D in [Figure 2](#page-5-1). Test Patter: 66 Zeroes, 1010, PRBS7, 66 ones, 0101 Inverted PRBS7.

**Note 5:** The output voltage range in which a linear relationship between the input and output maintains less than or equal to 1dB compression.

**Note 6:** Measured using a vector-network analyzer (VNA) with -15dBm power level applied to the adjacent input. The VNA detects the signal at the output of the victim channel. All other inputs and outputs are terminated with 50Ω.

Note 7: Refer to UM10204: I<sup>2</sup>C-bus specification and user manual, Rev. 03 - 19 June 2007.

<span id="page-5-0"></span>

*Figure 1. Recommended Supply Filtering*

<span id="page-5-1"></span>

*Figure 2. Receiver Test Setup (Points Labeled A, B, and D are Referenced for AC Parameter Test Conditions)*



*Figure 3. Noise Test Configuration*



*Figure 4. Channel-Isolation Test Configuration*

## **Typical Operating Characteristics**

(Typical values are at  $V_{CCR} = V_{CCT} = V_{CC\_DG} = 2.5V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



## **Typical Operating Characteristics (continued)**

(Typical values are at  $V_{CCR} = V_{CCT} = V_{CC\ DG} = 2.5V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



50mV/div

**SINGLE-ENDED OUTPUT FROM BERT SOURCE (12Gbps)**







**MAX24101 SINGLE-ENDED OUTPUT AFTER 18in OF INPUT FR4 (EQx[3:0] = 1110, FGx[1:0] = 01, TXAx[1:0] = 11, 13.5Gbps)**



**SINGLE-ENDED OUTPUT FROM BERT SOURCE AFTER 18in FR4 (12Gbps)**



**MAX24101 SINGLE-ENDED TIME DOMAIN OUTPUT VS. EQUALIZATION LEVEL (FGx[1:0] = 01, TXAx[1:0] = 11, WITH 18in FR4 AT 1Gbps)**



# **Pin Configuration**



# **Pin Description**



# **Pin Description (continued)**



## **Functional Diagram**



## **Detailed Description**

The MAX24101 is an 8-channel linear equalizer (EQ) functioning up to 15Gbps. Each channel has a programmable equalization network and programmable flat gain adjust. All controls for equalization, gain, output enable/ disable, etc., are individually programmed through the onchip programming block. The programming block can be controlled either through pin controls or the I2C serial bus.

## **APPLICATION Pin Control**

The placement range of a linear equalizer is limited by its dynamic range and noise performance. To allow the widest placement range, the MAX24101 has two optimizations. The two cases are Short and Long Channels. By selecting the case based on channel loss as shown in [Table 1,](#page-11-0) the best dynamic range and noise operating points are selected for the application.

## **Input Termination**

The input termination consists of two 50Ω resistors forming a differential termination between the input pins. The excellent return loss minimizes reflections in a channel.

## <span id="page-11-0"></span>**Table 1. APPLICATION Pin Control**



### **Receive Equalizer**

For the MAX24101, the input data goes into a selectable equalization stage. The receive equalizer is designed to compensate losses up to 19dB (at 7.5GHz) of channel loss. The selectable equalization can be controlled using commands sent over the I2C serial bus or pin control. With pin control the equalization setting has three available compensation levels and all the channels are controlled globally. See [Table 2](#page-12-0) for details. With the I2C serial bus, the equalization has 16 settings and each channel can be adjusted independently.

### **Gain Stage**

The MAX24101 data path goes through a wideband flat gain stage. With pin control the flat gain can be adjusted globally from -2.9dB to +1.7dB as shown in [Table 3](#page-12-1). With

I2C control, the flat gain can be adjusted independently for each channel.

### **Output Stage**

The MAX24101 data path transitions from the gain stages into a linear output buffer with selectable output level. With pin control the output levels can be adjusted globally as shown in [Table 4](#page-12-2). With I2C control, the output levels can be adjusted independently for each channel.

### **Power Saving**

The MAX24101 features a power-down enable input (ENABLE) pin to shut down the device and reduce supply current at startup. Set high to power down the output stage of all channels. Set open to power up all channels. Set low for reset. Reset disables all communication to the chip along with resetting the registers to their default states.

## <span id="page-12-0"></span>**Table 2. EQ\_PEAKING Pin Control**



## <span id="page-12-1"></span>**Table 3. FLAT\_GAIN Pin Control**



## <span id="page-12-2"></span>**Table 4. OUTPUT\_LEVEL Pin Control**



## **Table 5. ENABLE and Reset Pin Control**



## **Applications Information**

### **Linear Equalizer (EQ) Placement and Use, in 3 Steps**

Placement of linear equalizers in lossy channels is bounded by output linearity and input noise  $(I_{\rm RN})$ . See [Figure 5.](#page-13-0) Although placement is quite flexible, it is important to maintain linear operation with sufficient SNR, hence the boundary conditions stated in the following two sections.

### **Definitions**

 $dBV$  is defined as dB relative to  $1V_{P-P}$  (differential). Hence, the Tx level of 1Vp<sub>-P</sub> is 0dBV, and a Tx level of  $0.5V<sub>P-P</sub>$  is -6dBV.

**Source Tx Level [dBV]** is the total measured Tx V<sub>P-P</sub>, including pre-emphasis.

**Desired Margin** is a user decision regarding margin needed to account for all system min/max variations, including source Tx, MAX24101, and ASIC receiver.

<span id="page-13-0"></span>

*Figure 5. Linear Equalizer Placement*

### **Step 1—Maintain EQ Linearity at Low Frequency (LF)**

The source Tx low frequency (LF) amplitude needs to be considered to keep linear EQ within its linear range. The source Tx low-frequency (LF) amplitude is the differential peak-peak amplitude after any pre-emphasis has fully settled, e.g., the level of long CID (continuous identical digits) sequences. The primary controls over LF levels in Linear EQ are the Used ASIC Source Tx pre-emphasis (or deemphasis) and the Linear EQ Flat Gain (MAX24101).

[Figure 5](#page-13-0) shows a typical example with ASIC Source Tx having 6dB pre-emphasis, with  $1V_{P-P}$  peak swing and 0.5V<sub>P-P</sub> swing after pre-emphasis (e.g., long CID LF content). Note that  $0.5V_{P-P}$  fits easily under the -1dB Compression line. If the Source Tx were to have higher LF swing, driving linear EQ into nonlinearity, the linear EQ flat-gain control can be used to attenuate input signal level, as needed, to maintain linearity.

For example:

Maximum Linear EQ Flat Gain setting = 

 Linear EQ Output Level setting (-1dB compression) [dBV] -

 Source Tx Level [dBV] +

 Source Tx Pre-Emphasis (De-emphasis) [dB] -

User System Margin [dB]

For example:

 Linear EQ Output Level setting (-1dB compression)  $[dBV] = -3dBV$ 

 Source Tx Level [dBV] = 0dB

 Source Tx Pre-Emphasis (De-emphasis) [dB] = 6dB User System Margin = 2dB

Then:

Maximum Linear EQ Flat Gain setting =  $(-3) - 0 + 6 - 2$  $= 1dB$ 

(There are three Flat Gain settings available lower than +1dB: They are -3dB, -1.5dB, 0dB)

### **Step 2—Maintain EQ Linearity at High Frequency (Nyquist)**

A linear equalizer when placed too close to a Source Tx is vulnerable to nonlinear compression at high frequency (Nyquist), especially if the EQ peaking gain is higher than the preceding channel loss. The -1dB compression specification gives maximum output level that guarantees linear operation. As a function of the EQ settings, the minimum placement distance from the Source Tx is calculated as follows: (see **Position 1** in [Figure 5\)](#page-13-0).

Minimum Distance (Nyquist Loss) from Source Tx [dB] = Source Tx Level [dBV] +

 Linear EQ Peaking Gain [dB] +

 Linear EQ Flat Gain [dB] –

 Linear EQ Output Level setting (-1dB Compression level) [dBV] +

User System Margin [dB]

For example:

 Source Tx Level = 0dBV

 Linear EQ Peaking Gain = 14dB

 Linear EQ Flat Gain = 0dB

 Linear EQ Output Level setting (-1dB Compression Point) = -3dBV

User System Margin = 2dB

Then:

Minimum Distance (Nyquist Loss) from Source  $Tx = 0$  $+ 14 + 0 - (-3) + 2 = 19dB$ 

### **Step 3—Keep Nyquist Level Sufficiently Above Noise Floor**

The amplitude of the Nyquist sequence (10101010…) must be maintained sufficiently above noise floor to achieve BER goals. Hence, Nyquist level at input to the Linear EQ needs to be sufficiently above the Linear EQ self-noise, IRN (input referred noise). This sets the maximum Nyquist channel loss preceding the Linear EQ, e.g, farthest placement from Source Tx (see **Position 2** in [Figure 5](#page-13-0)).

Maximum Distance (Nyquist Loss) from Source Tx [dB] =

 Source Tx Level (which is Nyquist level) [dBV] –

 Linear EQ IRNpp at BER goal [dBV] –

 Margin required to reduce RJ creation –

User System Margin [dB]

For example:

 Source Tx Level = 0dBV

 Linear EQ IRNpp at BER goal (0.5mVrms x 15.9 at BER 1E-15) [dBV] = -43dB

 Margin required to reduce RJ creation (to 0.2UIpp at BER) = 10dB

User System Margin = 3dB

Then:

Maximum Distance (Nyquist Loss) from Source 
$$
Tx = 0 - (-43) - 10 - 3 = 30dB
$$

### **Tools—Frequency Response Plotting and EQ Placement in Channel Calculator**

Several simple Microsoft® Excel spreadsheet tools are available to assist in the application of the MAX24101 Linear EQs. Please visit **www.maximintegrated.com** to access the latest version of these spreadsheets:

### **I2C Interface**

The SDA and SCL pins are referred to as the slave I2C. The slave I2C provides external access to the register set within the MAX24101. Typically, an MCU is connected to the slave I2C.

### **Framing and Data Transfer**

An individual transaction is framed by a START condition and a STOP condition. A START condition occurs when a bus master pulls SDA low while SCL is high. A STOP condition occurs when the bus master allows SDA to transition low-to-high when SCL is high. Within the frame the master has exclusive control of the bus. The MAX24101 supports Repeated START conditions whereby the master may simultaneously end one frame and start another without releasing the bus by replacing the STOP condition with a START condition.

Within a frame the state of SDA only changes when SCL is low. A data bit is transferred on a low-to-high transition

of SCL. Data is arranged in packets of 9 bits. The first 8 bits represent data to be transferred (most significant bit (MSB) first). The last bit is an acknowledge bit from the slave. The recipient of the data holds SDA low during the ninth clock cycle of a data packet to acknowledge (ACK) the byte. Leaving SDA left open on the ninth bit signals a not-acknowledged (NACK) condition. The interpretation of the acknowledge bit by the sender depends on the type of transaction and the nature of the byte being received. SDA is bidirectional so that the master may send data bytes during write transactions and the slave may send data bytes during reads.

### **Device Addressing**

The first byte to be sent after a START condition is a slave address byte. The first seven bits of the byte contain the target slave address (MSB first). The eighth bit indicates the transaction type  $-10'$  = write,  $1'$  = read. Each slave interface on the bus is assigned a 7-bit slave address. If no slave matches the address broadcast by the master then SDA will be left open during the acknowledge bit and the master receives a NACK. The master must then assert a STOP condition. If a slave identifies the address then it acknowledges it by pulling SDA low. The master then proceeds with the transaction identified by the type bit. The two-wire interface of the MAX24101 decodes slave addresses ranging from 00h to 3Fh.





*Microsoft Excel is a registered trademark of Microsoft Corp.*



*Figure 7. EQ Placement Calculator*

### **Write Transaction**

In a write transaction, the address byte is successfully acknowledged by the slave, and the type bit is set low. After the first acknowledge, the master sends a single data byte. All signaling is controlled by the master except for the SDA line during the acknowledge bits. During the acknowledge cycle the direction of the SDA line is reversed and the slave pulls SDA low to return a '0' (ACK) to the master.

The MAX24101 interprets the first data byte as a register address. This is used to set an internal memory pointer. Subsequent data bytes within the same transaction will then be written to the memory location addressed by the pointer. The pointer is auto-incremented after each byte. There is no limit to the number of bytes which may be written in a single burst to the internal registers of the MAX24101.

### **Read Transaction**

In a read transaction, the slave address byte is successfully acknowledged by the slave, and the type bit is set high. After the ACK the slave returns a byte from the location identified by the internal memory pointer. This pointer is then auto-incremented. The slave then releases SDA so that the master can ACK the byte. If the slave receives an ACK then it will send another byte. The master identifies the last byte by sending a NACK to the slave. The master then issues a STOP to terminate the transaction.

Thus, to implement a random access read transaction, a write must first be issued by the master containing a slave address byte and a single data byte (the register address). This sets up the memory pointer. A read is then sent to retrieve data from this address.



*Figure 8. Device Addressing*

### **I2C Access Destination**

The MAX24101 does not provide any security level on the I2C serial bus. Accesses to unimplemented registers in the device are discarded in the case of a write, and return an unpredictable value in the case of a read. During burst mode accesses, destination addresses are tested on a byte-by-byte basis.

### **Slave Address Configuration**

The slave address of the MAX24101 I2C can be set using an initialization procedure involving PGM IN and PGM\_OUT, in conjunction with the standard I<sup>2</sup>C signals. This procedure facilitates the assignment of a large number of slave addresses, enabling several MAX24101s to be controlled by a single I2C serial bus and commands. All transactions on the I<sup>2</sup>C bus follow standard protocol. allowing simple firmware development.

There is little difference between a normal I2C serial bus and the MAX24101 solution except that there is a new signal which controls the programming of the device addresses. This signal is daisy-chained through all of the devices on the I<sup>2</sup>C bus via the  $\overline{PGM}$  IN and the  $\overline{PGM}$ OUT pins. The programming of device addresses is done as a single parallel write to all devices 1 to N.

The I2C bus is the usual "SCL" and bidirectional "SDA" with the pullup. The "program reset" signal is a single bit passed through each device as a flying enable. The input pin for this signal is PGM IN and the corresponding output pin is PGM\_OUT. The PGM\_IN pin on the first MAX24101 in the chain can be tied low or left unconnected because the PGM IN pin has an internal pulldown resistor.





*Figure 10. Read Transaction*

### **I2C Address Configuration**

The new features of this interface compared to a conventional I2C interface are:

- The daisy chain PGM\_IN and PGM\_OUT pins
- $\bullet$  A device address register (7 bits[7:1] ). Bit[0] in this register is used as a I2C read/write bit
- An internal "write\_once" bit

At power-up, the "write\_once" bit will be set to '1' and the device I2C address will be set to its default value (A2h). All MAX24101 devices will respond to read and writes to this slave address until a write to register 3Ch is performed. The required I2C address of device 1 ("7 bit address"+'0') is then assigned by writing to pgm\_register (3Ch) at I2C address A2h. All devices accept the new address value (for example: 10h). Each device then starts to increment it on SCL edges while PGM\_IN is high. The "program reset" signal ripples down the chain, fixing the I2C address such that device N has an I2C address of ("address"+'0')+2\*N-1 (for example: device 1 at (10h and 12h), device 2 at (14h and 16h) and device 3 at (18h and 1Ah)). Note that each MAX24101 takes two I2C addresses with channels 1 to 4 being controlled by the lower address and channels 5 to 8 from the upper address.



*Figure 11. Slave Address Configuration*

### **Startup Sequence**

In this example, a chain of MAX24101s are loaded with the required I<sup>2</sup>C slave address.

- 1) Power up the devices.
- 2) Write I<sup>2</sup>C sequence < "A2h" ack "3Ch" ack "address" and '0' ack>.
- 3) The first device is now accessible at its given address ("address" and '0' for the lower channels and "address+1" and '0' for the upper channels).
- 4) By accessing the first device, the SCL pin is toggled and hence the "program\_reset" signal is propagated through the devices using the PGM IN and PGM\_OUT pins. For long chains, a number of accesses may be needed before all devices have an assigned address since each access results in 27 SCL transitions and hence 13 devices are allocated an address

**To reset the slave address requires a power cycle or setting the ENABLE pin low.**

## **Programming Tables**

## **Table 6. EQ\_PEAKING Bit Control**



## **Table 7. FLAT\_GAIN Bit Control**



## **Table 8. OUTPUT\_LEVEL Bit Control**



## **Register Map**

## **Table 9. Register Configuration**



**The register map is split into two sections depending on the I2C address used. In general the lower address controls the lower four channels and the upper I2C address controls the upper four channels.** 

### **Register 01h (Lower I2C Address): Channel 1**



EQ1[3:0]: Sets the equalizer peaking for channel 1. See Table 6 for values.

FG1[1:0]: Sets the flat gain for channel 1. See Table 7 for values.

TXA1[1:0]: Sets the output amplitude for channel 1. See Table 8 for values.

### **Register 02h (Lower I2C Address): Channel 2**



EQ2[3:0]: Sets the equalizer peaking for channel 2. See Table 6 for values.

FG2[1:0]: Sets the flat gain for channel 2. See Table 7 for values.

TXA2[1:0]: Sets the output amplitude for channel 2. See Table 8 for values.

### **Register 03h (Lower I2C Address): Channel 3**



EQ3[3:0]: Sets the equalizer peaking for channel 3. See Table 6 for values.

FG3[1:0]: Sets the flat gain for channel 3. See Table 7 for values.

TXA3[1:0]: Sets the output amplitude for channel 3. See Table 8 for values.

### **Register 04h (Lower I2C Address): Channel 4**



EQ4[3:0]: Sets the equalizer peaking for channel 3. See Table 6 for values.

FG4[1:0]: Sets the flat gain for channel 3. See Table 7 for values.

TXA4[1:0]: Sets the output amplitude for channel 3. See Table 8 for values.

### **Register 05h (Lower I2C Address): Channel 1–4 Controls**



REGCONT14: Selects channel settings, for channels 1–4, from pin control or I 2 C accessible registers. 0 = pin control (equalizer peaking, flat gain and output amplitude),  $1 = 12C$  accessible registers.

CH1OFF: Disables channel 1. 0 = enabled, 1 = disabled.

CH2OFF: Disables channel 2. 0 = enabled, 1 = disabled.

CH3OFF: Disables channel 3. 0 = enabled, 1 = disabled.

CH4OFF: Disables channel 4. 0 = enabled, 1 = disabled.

### **Register 01h (Upper I2C Address): Channel 5**



EQ5[3:0]: Sets the equalizer peaking for channel 5. See Table 6 for values.

FG5[1:0]: Sets the flat gain for channel 5. See Table 7 for values.

TXA5[1:0]: Sets the output amplitude for channel 5. See Table 8 for values.

### **Register 02h (Upper I2C Address): Channel 6**



EQ6[3:0]: Sets the equalizer peaking for channel 6. See Table 6 for values.

FG6[1:0]: Sets the flat gain for channel 6. See Table 7 for values.

TXA6[1:0]: Sets the output amplitude for channel 6. See Table 8 for values.

### **Register 03h (Upper I2C Address): Channel 7**



EQ7[3:0]: Sets the equalizer peaking for channel 7. See Table 6 for values.

FG7[1:0]: Sets the flat gain for channel 7. See Table 7 for values.

TXA7[1:0]: Sets the output amplitude for channel 7. See Table 8 for values.

### **Register 04h (Upper I2C Address): Channel 8**



EQ8[3:0]: Sets the equalizer peaking for channel 8. See Table 6 for values.

FG8[1:0]: Sets the flat gain for channel 8. See Table 7 for values.

TXA8[1:0]: Sets the output amplitude for channel 8. See Table 8 for values.

### **Register 05h (Upper I2C Address): Channel 5-8 Controls**



REGCONT58: Selects channel settings, for channels 5-8, from pin control or I 2 C accessible registers. 0 = pin control (equalizer peaking, flat gain and output amplitude),  $1 = 12C$  accessible registers.

CH5OFF: Disables channel 5. 0 = enabled, 1 = disabled.

CH6OFF: Disables channel 6. 0 = enabled, 1 = disabled.

CH7OFF: Disables channel 7. 0 = enabled, 1 = disabled.

CH8OFF: Disables channel 8. 0 = enabled, 1 = disabled.

## **Exposed Pad Package**

The exposed pad of the MAX24101 package incorporates features that provide a very low thermal resistance path for heat removal from the IC. The exposed pad on the MAX24101 must be soldered to the circuit board for proper thermal performance and correct electrical grounding. For more information on exposed-pad packages, refer to Maxim Application Note 862: [HFAN-08.1:](http://www.maximintegrated.com/an862) *[Thermal Considerations of QFN and Other Exposed-](http://www.maximintegrated.com/an862)[Paddle Packages](http://www.maximintegrated.com/an862)*.

### **Layout Considerations**

Circuit board layout and design can significantly affect the performance of the MAX24101. Use good high-frequency design techniques, including minimizing ground inductance and using controlled-impedance transmission lines on the data signals. Power-supply decoupling should also be placed as close to the  $V_{CC}$  pins as possible. There should be sufficient supply filtering. Always connect all  $V_{\rm CC}$ s to a power plane. Take care to isolate the input from the output signals to reduce feed through.

## **Interface Schematics**



*Figure 12. CML Equivalent Input Structure Figure 13. CML Equivalent Output Structure*



## <span id="page-25-0"></span>**Ordering Information**



*+Denotes a lead(Pb)-free/RoHS-compliant package.*

*\*EP = Exposed pad*

## **Chip Information**

PROCESS: SiGe BiCMOS

## **Package Information**

For the latest package outline information and land patterns (footprints), go to **www.maximintegrated.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

